

## 1. General description

Dual common cathode power Schottky diode designed for high frequency switched mode power supplies in a TO220F "full pack" plastic package.



## 2. Features and benefits

- Trench structure
- High junction temperature up to 150°C
- Low forward voltage drop, negligible switching losses
- High efficiency

## 3. Applications

- DC to DC converters
- Freewheeling diode
- OR-ing diode
- Switched mode power supply rectifier

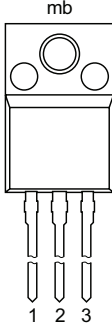
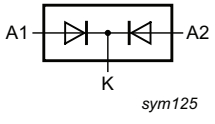
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes	Values			Unit
<b>Absolute maximum rating</b>							
$V_{RRM}$	repetitive peak reverse voltage			60			V
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; square-wave pulse; per diode; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a>		15			A
$I_{O(AV)}$	average output current	$\delta = 0.5$ ; square-wave pulse; both diodes conducting		30			A
Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
<b>Static characteristics</b>							
$V_F$	forward voltage	$I_F = 15$ A; $T_j = 25$ °C; per diode; <a href="#">Fig. 6</a>		-	0.57	0.65	V
$I_R$	reverse current	$V_R = 60$ V; $T_j = 25$ °C; per diode; <a href="#">Fig. 7</a> ; <a href="#">Fig. 8</a>		-	40	100	μA

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1		
2	K	cathode		
3	A2	anode 2		
mb	n.c.	mounting base; isolated		

## 6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WN3S30H60CX	TO220F	WN3S30H60CXQ	Tube	50	SOT186A	14-Nov-2013

## 7. Marking

Table 4. Marking codes

Type number	Marking codes
WN3S30H60CX	WN3S30 H60CX

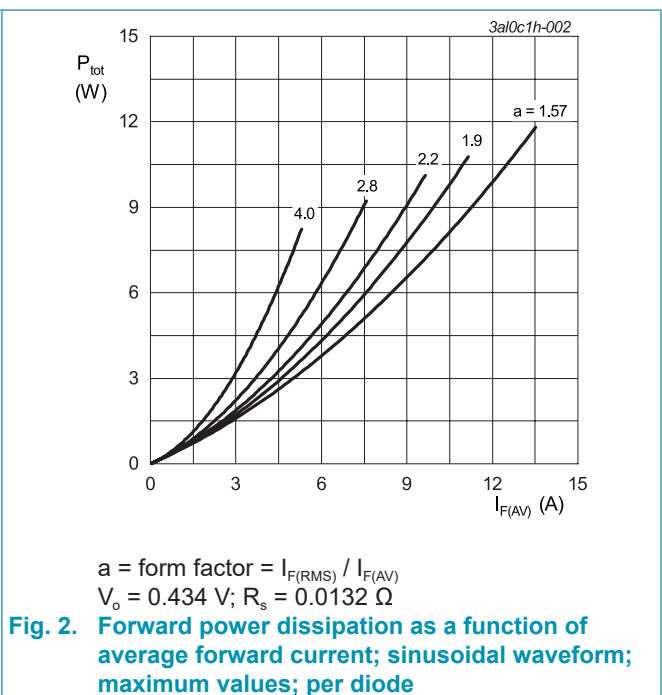
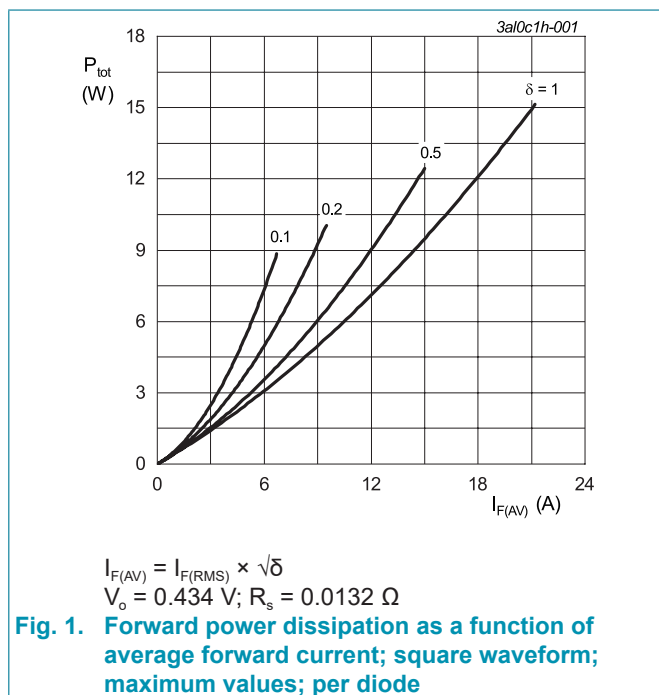
## 8. Limiting values

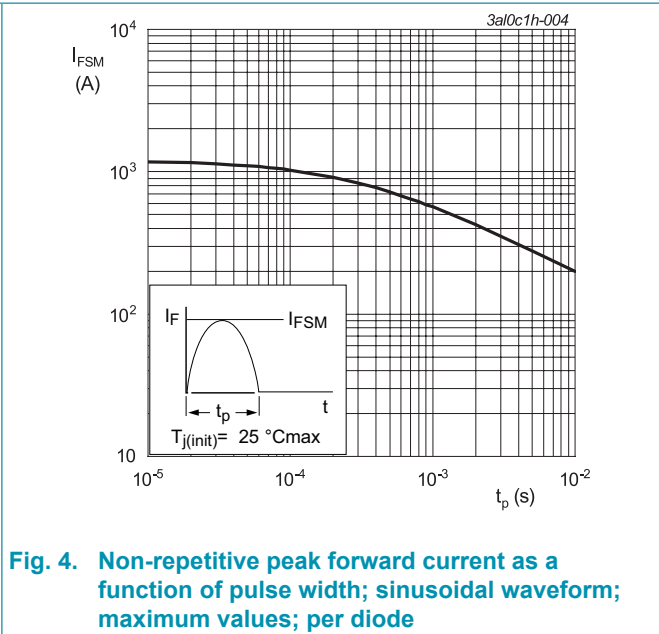
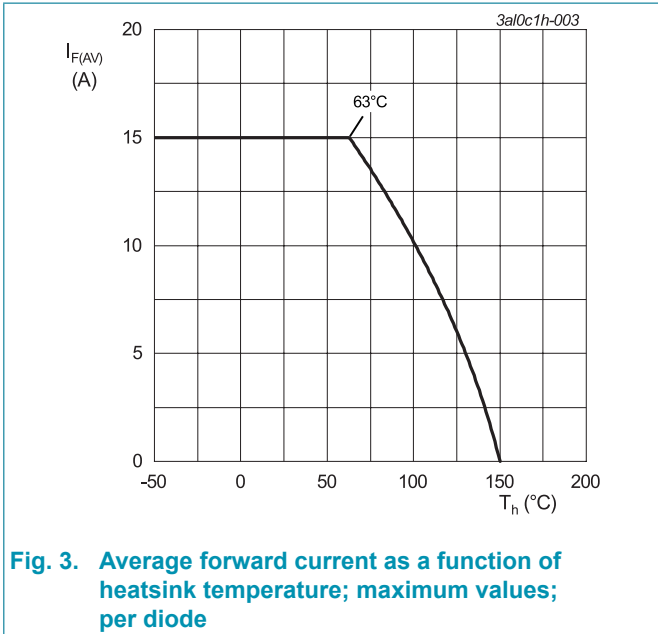
**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{RRM}$	repetitive peak reverse voltage			60	V
$V_{RWM}$	crest working reverse voltage			60	V
$V_R$	reverse voltage	DC		60	V
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; square-wave pulse; per diode; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a>		15	A
$I_{O(AV)}$	average output current	$\delta = 0.5$ ; square-wave pulse; both diodes conducting		30	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 10$ ms; $T_{j(\text{init})} = 25$ °C; sine-wave pulse; per diode; <a href="#">Fig. 4</a>		200	A
		$t_p = 8.3$ ms; $T_{j(\text{init})} = 25$ °C; sine-wave pulse; per diode		220	A
$T_{\text{stg}}$	storage temperature			-40 to 150	°C
$T_j$	junction temperature		[1]	-40 to 150	°C

[1] The heat generated must be less than the thermal conductivity from Junction to Ambient:  $dP_{\text{tot}}/dT_j < 1/R_{\text{th}(j-a)}$

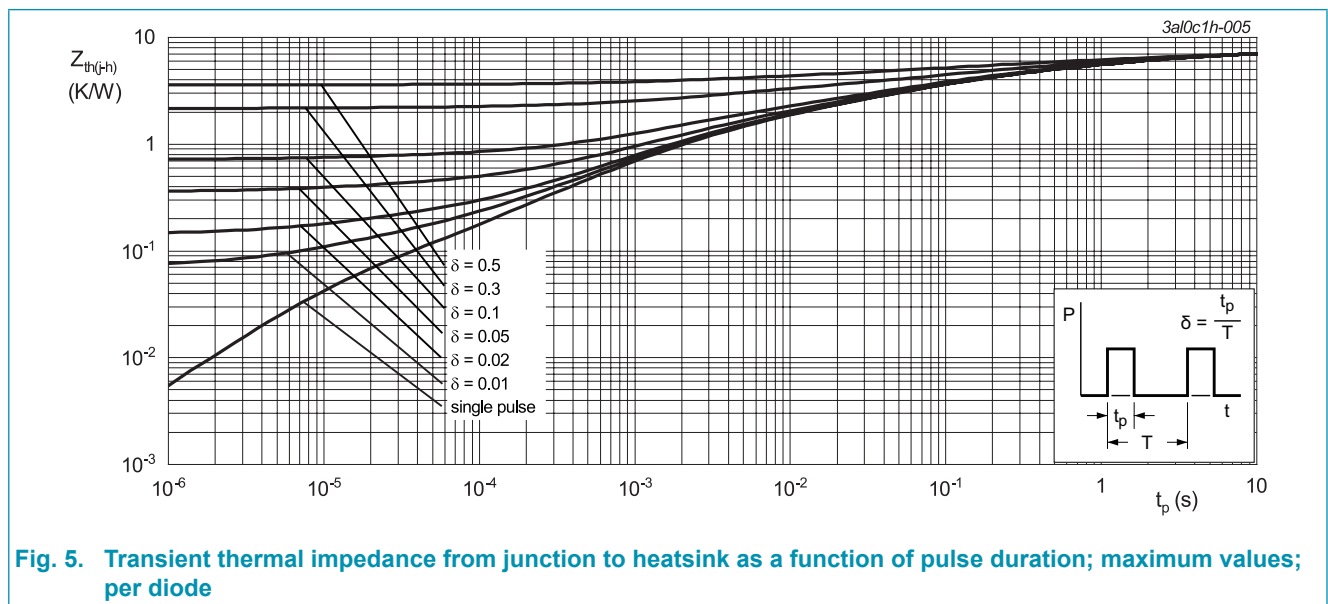




## 9. Thermal characteristics

**Table 6. Thermal characteristics**

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$R_{th(j-h)}$	thermal resistance from junction to heatsink	with heatsink compound; per diode; <a href="#">Fig. 5</a>		-	-	7	K/W
		with heatsink compound; both diodes conducting		-	-	4.8	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	65	-	K/W



**Fig. 5. Transient thermal impedance from junction to heatsink as a function of pulse duration; maximum values; per diode**

## 10. Isolation characteristics

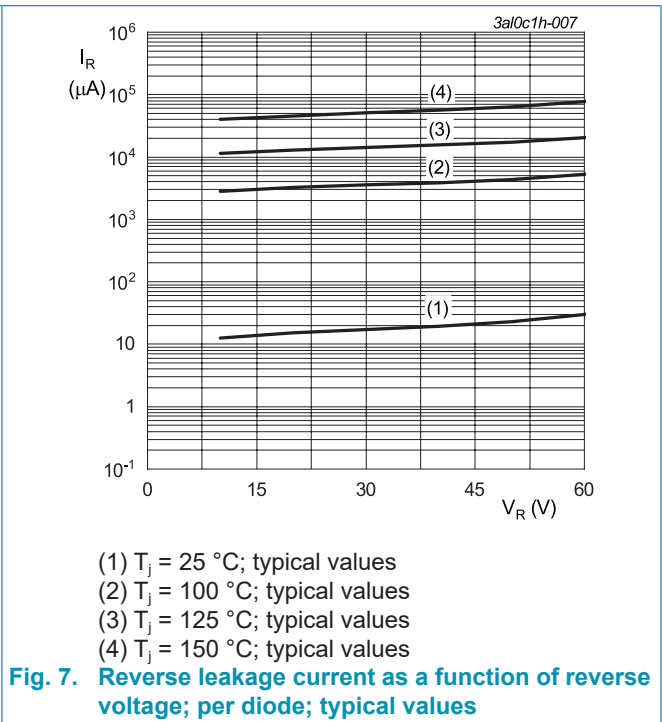
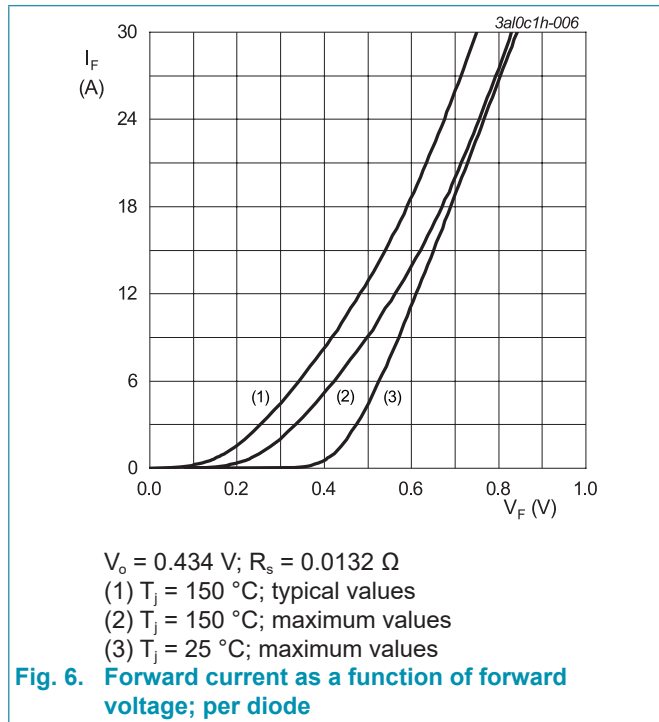
**Table 7. Isolation characteristics**

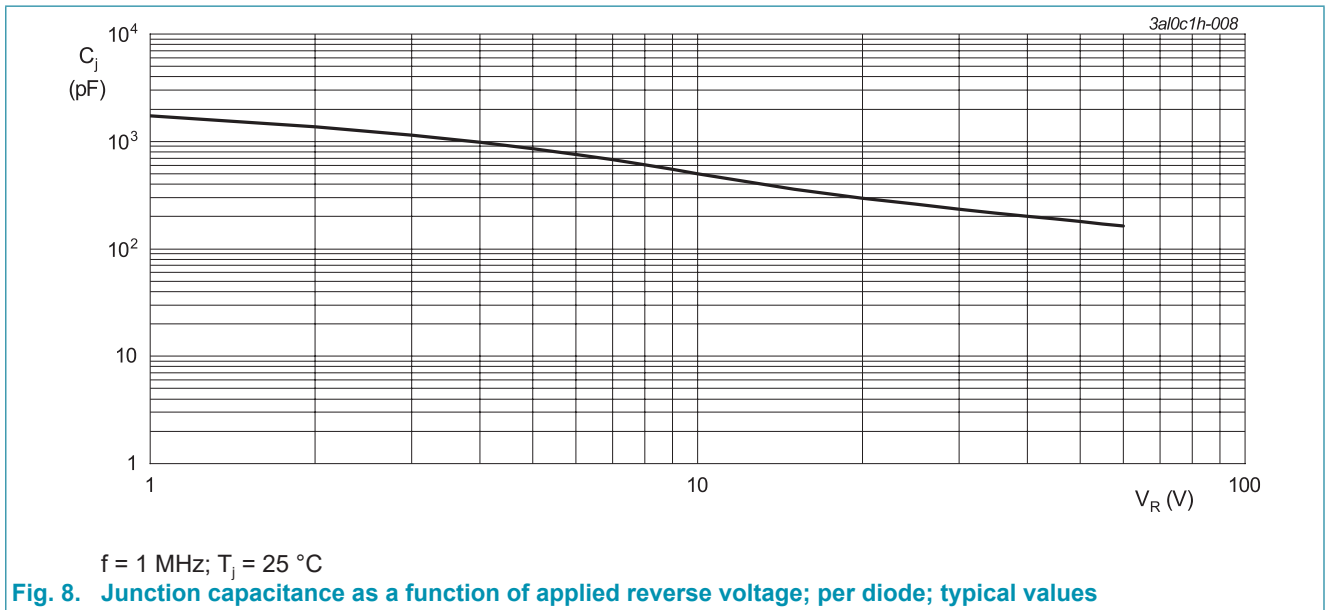
Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$V_{isol(RMS)}$	RMS isolation voltage	from all terminals to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz $\leq f \leq$ 60 Hz; $T_h = 25^\circ\text{C}$ ; RH $\leq 65\%$		-	-	2500	V

### 11. Characteristics

Table 8. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
<b>Static characteristics</b>							
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 15 A; T <sub>j</sub> = 25 °C; per diode; <a href="#">Fig. 6</a>		-	0.57	0.65	V
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 125 °C; per diode; <a href="#">Fig. 6</a>		-	0.55	-	V
		I <sub>F</sub> = 3 A; T <sub>j</sub> = 25 °C; per diode; <a href="#">Fig. 6</a>		-	0.39	-	V
		I <sub>F</sub> = 3 A; T <sub>j</sub> = 125 °C; per diode; <a href="#">Fig. 6</a>		-	0.29	-	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 60 V; T <sub>j</sub> = 25 °C; per diode; <a href="#">Fig. 7</a> ; <a href="#">Fig. 8</a>		-	40	100	μA
		V <sub>R</sub> = 60 V; T <sub>j</sub> = 125 °C; per diode; <a href="#">Fig. 7</a> ; <a href="#">Fig. 8</a>		-	25	100	mA

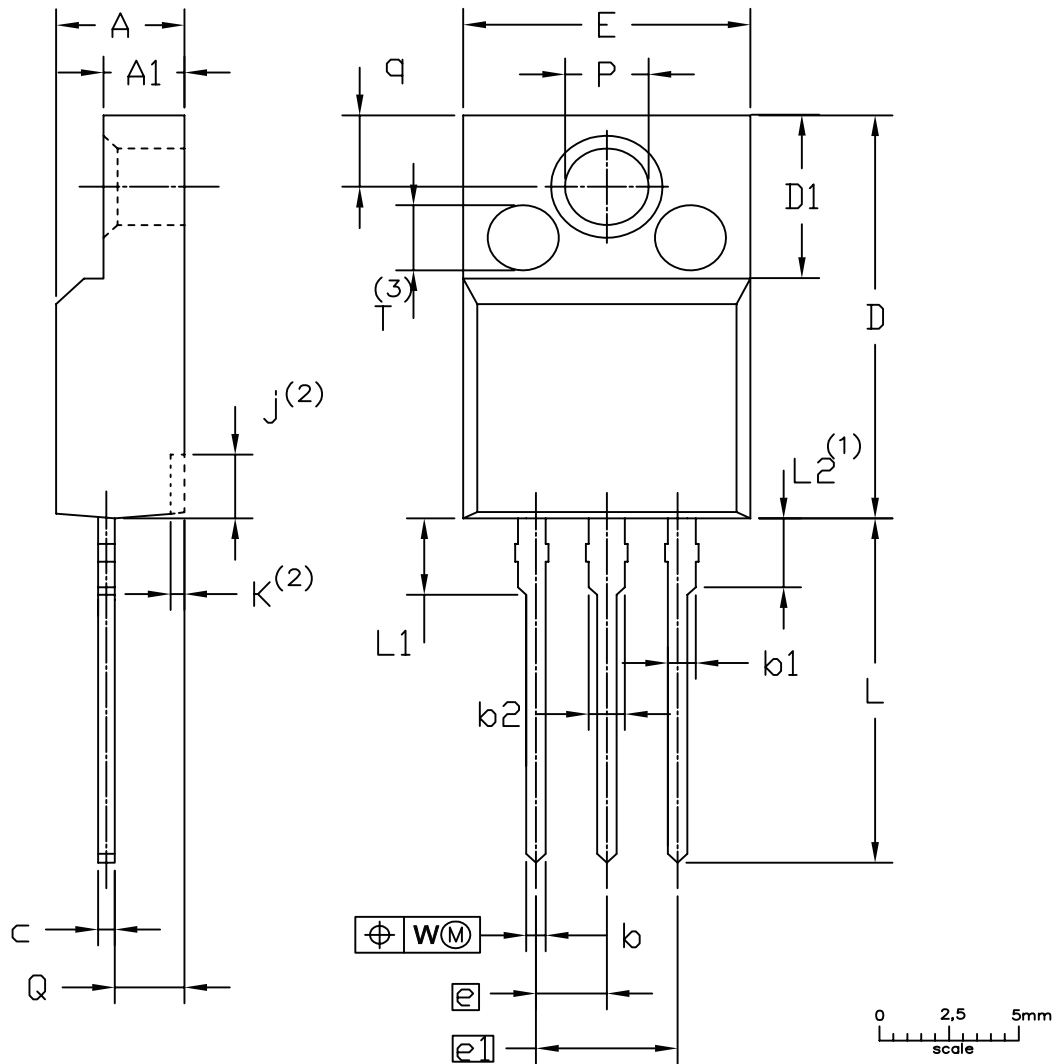




## 12. Package outline

Plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack"

SOT186A



UNIT	A	A <sub>1</sub>	b	b <sub>1</sub>	b <sub>2</sub>	c	D	D <sub>1</sub>	E	e	e <sub>1</sub>	j <sup>(2)</sup>	k <sup>(2)</sup>	L	L <sub>1</sub>	L <sub>2</sub> <sup>(1)</sup> max.	P	Q	q	W	T <sup>(3)</sup>
mm	4.6	2.9	0.9	1.1	1.4	0.7	15.8	6.5	10.3	2.54	5.08	2.7	0.6	14.4	3.30	3	3.2	2.6	3.0	0.4	2.5
	4.0	2.5	0.7	0.9	1.0	0.4	15.2	6.3	9.7			1.7	0.4	13.5	2.79		3.0	2.3	2.6		

**Notes**

- Terminal dimensions within this zone are uncontrolled
- Dot lines area designs may vary
- Eject pin mark is for reference only

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
SOT186A		3 LEADS TO220F			2013-11-14



## 13. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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